



MCSM2512 Series

Metal Strip Current Sensing Resistors

Document No:2W04

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Version : A004

APPROVAL SHEET

| | |
|----------------------|---|
| Model Name | Metal Strip Current Sensing Resistor |
| Part Number | IMCSM2512R002FEEA |
| Customer Name | |
| Customer P/N | |
| Issued Date | |

| Customer | | Maker | | |
|----------|---------|-----------------|-----------------|-----------------|
| Approved | Checked | Inspector | Checked | Prepared |
| | | <i>Cody Liu</i> | <i>Cody Liu</i> | <i>Cody Liu</i> |

•All Specifications are subject to change without notice.

Features

- ◆Able to withstand high temperature and high current
- ◆Ultra Low sensing resistance
- ◆Excellent frequency response
- ◆Chip size: 2512
- ◆Lead free, RoHS compliant for global applications halogen free

Application

- ◆Mobile electronic equipment-Cellular phone, NB Tablet PC, GPS, DSC, HDD
- ◆DC-DC converter, Adapter, Battery pack and charger
- ◆Switching power supply
- ◆Voltage Regulation module and
- ◆Power management applications

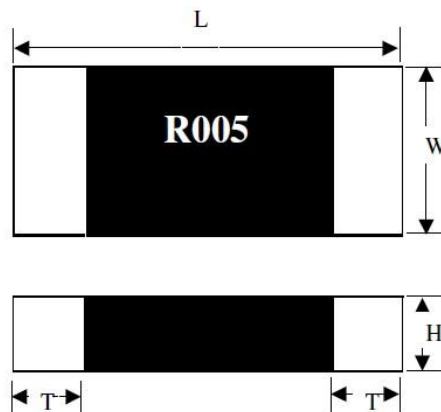
Part Numbering System

IMCSM 2512 R002 F E E A

(1) (2) (3) (4) (5) (6)

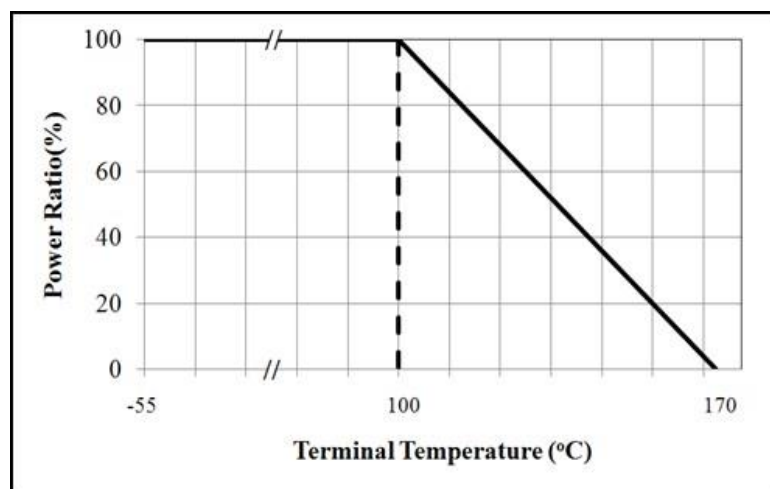
- (1) Series Code
- (2) Size (EIA): Length x Width
- (3) Resistance: R002=2m Ω , R010=10m Ω , R050=50m Ω
- (4) Tolerance: F=+/-1%, G=+/-2%, J=+/-5%
- (5) Power Rating: S=0.5W, C=1W, D=1.5W, E=2W, H=3W, P=4W, I=5W
- (6) Packaging: T- Embossed paper tape, 7" reel
E-Embossed plastic tape, 7" reel
- (7) Special: A=Stander M=Low EMF

Dimension

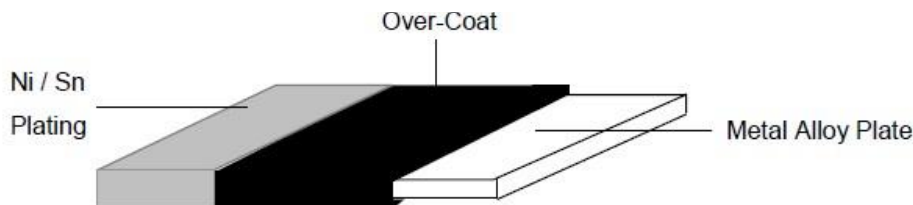


| TYPE | Resistance Range (Ω) | T.C.R (ppm/ $^{\circ}$ C) Max. & Material | Power Rating (watts) | Dimensions-mm(inches) | | | |
|------|-------------------------------|---|----------------------|-------------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|
| | | | | L | W | H | T |
| 0805 | 0.001~0.05 | MnCu \pm 75 R \leq 20m Ω FeCrAi \pm 100 R \geq 21m Ω | 0.25-0.5 | 2 \pm 0.25 (0.08 \pm 0.01) | 1.25 \pm 0.25 (0.05 \pm 0.01) | 0.65 \pm 0.25 (0.03 \pm 0.01) | 0.5 \pm 0.25 (0.02 \pm 0.01) |
| 1206 | 0.001~0.12 | MnCu \pm 75 R \leq 15m Ω FeCrAi \pm 100 R \geq 16m Ω | 0.5-1.0 | 3.1 \pm 0.25 (0.12 \pm 0.01) | 1.6 \pm 0.25 (0.06 \pm 0.01) | 0.75 \pm 0.25 (0.03 \pm 0.01) | 0.7 \pm 0.25 (0.03 \pm 0.01) |
| 2010 | 0.0005-0.029 | MnCu \pm 75 R \leq 15m Ω FeCrAi \pm 100 R \geq 16m Ω | 1W-2W | 5.1 \pm 0.25 (0.2 \pm 0.01) | 2.65 \pm 0.25 (0.1 \pm 0.01) | 0.85 \pm 0.25 (0.03 \pm 0.01) | 1.3 \pm 0.25 (0.05 \pm 0.01) |
| | 0.03-0.1 | | | | | | 0.7 \pm 0.25 (0.05 \pm 0.01) |
| 2512 | 0.0005-0.03 | CuNi \pm 50 R \leq 1m Ω MnCu \pm 75 R \leq 20m Ω FeCrAi \pm 100 R \geq 21m Ω | 2W-3W | 6.3 \pm 0.25 (0.3 \pm 0.01) | 3.2 \pm 0.25 (0.13 \pm 0.01) | 0.85 \pm 0.25 (0.03 \pm 0.01) | 1.9 \pm 0.25 (0.074 \pm 0.01) |
| | 0.004-0.059 | | 2W-3W | | | | 1.15 \pm 0.25 (0.05 \pm 0.01) |
| | 0.06-0.1 | | 1.5W-3W | | | | 0.8 \pm 0.25 (0.03 \pm 0.01) |
| | 0.11-0.2 | | 1.5W | | | | |
| 2725 | 0.0005-0.079 | MnCu \pm 75 R \leq 10m Ω FeCrAi \pm 100 R \geq 50m Ω | 3W-4W | 7.1 \pm 0.25 (0.3 \pm 0.01) | 6.3 \pm 0.25 (0.3 \pm 0.01) | 0.85 \pm 0.25 (0.03 \pm 0.01) | 1.9 \pm 0.25 (0.07 \pm 0.01) |
| | 0.08-0.1 | | | | | | 1.15 \pm 0.25 (0.05 \pm 0.01) |
| | | | | | | | 0.8 \pm 0.25 (0.03 \pm 0.01) |

Derating Curve



Construction



Performances

Environmental Performance

| No. | Item | Test Condition | Specification |
|-----|--|---|-----------------------------------|
| 1 | Short Time Overload | Voltage equal to 4 time rated power for 5 sec , (JIS-C5202-5.5) | R: $\pm(1\%+0.0005)$) |
| 2 | Temperature Coefficient of Resistance (T.C.R.) | $TCR \text{ (ppm/}^\circ\text{C)} = \frac{\Delta R}{R \times \Delta t} \times 10^6$ +25°C /+125°C. (JIS-C5202-5.2) | Refer to Electrical Specification |
| 3 | Damp Heat with Load | The specimens shall be placed in a chamber and subjected to a relative humidity of 90~95% percent and a temperature of 40° ±2°C for the period of 1000 hrs. (MIL-STD-202, Method 103) | R: $\pm(1\%+0.0005)$) |
| 4 | High Temperature Exposure | The ship (mounted on board) is exposed in the heat chamber 125±3°C for 1000 hrs. (JIS-C5202-7.2) | R: $\pm(1\%+0.0005)$) |
| 5 | Load Life | Apply rated power at 70±2°C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10) | R: $\pm(1\%+0.0005)$) |
| 6 | Rapid change of temperature | The chip (mounted on board) is exposed, -55±3°C (30min.)/+125±2°C (30min.) for 5 cycles. The following conditions as the following figure. (JIS-C5202-7.4) | R: $\pm(1\%+0.0005)$) |

Function Performance

| No. | Item | Test Condition | Specification |
|-----|---------------------------|---|---|
| 1 | Bending Strength | Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2mm(+0.2/-0mm) illustrated in the figure below and hold for 10±1 sec. (JIS-C5202-6.1) Unit: mm | R: ±(1%+0.0005) |
| 2 | Solvent Resistance | The chip is completed immersion of the specimens in the isopropyl alcohol for 3 *+5, -0) min., 25°C ±5°C. ((MIL-STD-202, Method 215) | Verify marking permanency. (Nor required for laser etched parts or parts with no marking) |
| 3 | Resistance to solder Heat | The specimen chip shall be immersed into the flux specified in the solder bath 260±5°C for 10±1 sec. (MIL-STD-202, Method 210) | R: ±(1%+0.0005) |
| 4 | Solderability | The specimen chip shall be immersed into the flux specified in the solder bath 235±5°C for 2±0.5 sec. It shall be immersed to a point 10mm from its root. (Sn96.5/Ag3.0/Cu0.5) (JIS-C5 202-6.11) | Solder shall be covered 95% or more of the electrode area. |

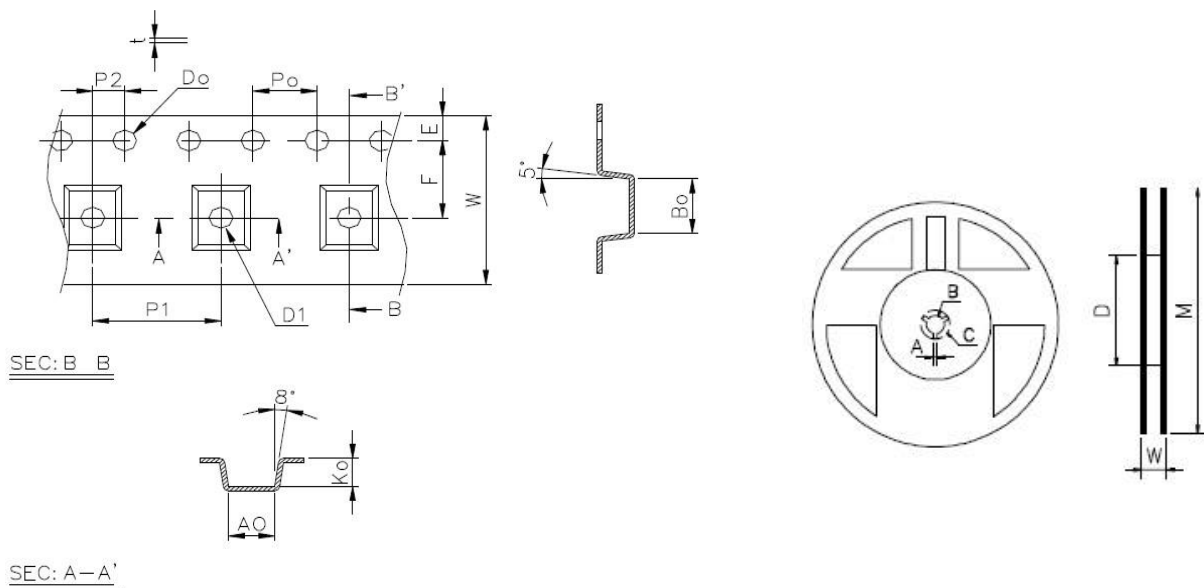
.Remark:

a. 3W with total solder pad trace size of 300mm² . The surface temperature of component should below 100°C .

●All Specifications are subject to change without notice.

Tape Packaging Specifications ♦Paper Tape Specifications

| Item | W | P1 | E | F | Do | D1 | P0 | P2 | Ao | Bo | Ko | t |
|-----------|-------|-------|-------|-------|-------|------|-------|-------|-------|-------|-------|-------|
| 0805 | 8.00 | 4.00 | 1.75 | 3.50 | 1.55 | 1.00 | 4.00 | 2.00 | 1.45 | 2.25 | 0.90 | 0.25 |
| 1206 | 8.00 | 4.00 | 1.75 | 3.50 | 1.55 | 1.00 | 4.00 | 2.00 | 1.83 | 3.50 | 0.90 | 0.20 |
| 2010 | 12.00 | 4.00 | 1.75 | 5.50 | 1.50 | 1.50 | 4.00 | 2.00 | 2.90 | 5.45 | 1.10 | 0.23 |
| 2512 | 12.00 | 8.00 | 1.75 | 5.50 | 1.55 | 1.50 | 4.00 | 2.00 | 3.90 | 6.74 | 1.08 | 0.24 |
| 2725 | 16.00 | 12.00 | 1.75 | 7.50 | 1.50 | --- | 4.00 | 2.00 | 6.5 | 7.25 | 1.200 | 0.30 |
| Tolerance | ±0.30 | ±0.10 | ±0.10 | ±0.05 | ±0.05 | MIN | ±0.10 | ±0.05 | ±0.10 | ±0.10 | ±0.10 | ±0.10 |



Unit : mm

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| Model | Reel | | | |
|-------|----------------------|----------|-------------|------|
| | Tape Width | Diameter | Pieces/Reel | Code |
| 0805 | 8mm/Embossd Plastic | 178mm/7" | 5,000 | 1 |
| 1206 | 8mm/Embossd Plastic | 178mm/7" | 2,000 | 1 |
| 2010 | 12mm/Embossd Plastic | 178mm/7" | 2,000 | 1 |
| 2512 | 12mm/Embossd Plastic | 178mm/7" | 2,000 | 1 |
| 2725 | 16mm/Embossd Plastic | 178mm/7" | 1000 | 1 |

Soldering Recommendations

◆ Peak reflow temperatures and durations :

- IR Reflow Peak = 260°C max for 10 sec

- Wave Solder = 260°C max for 10 sec

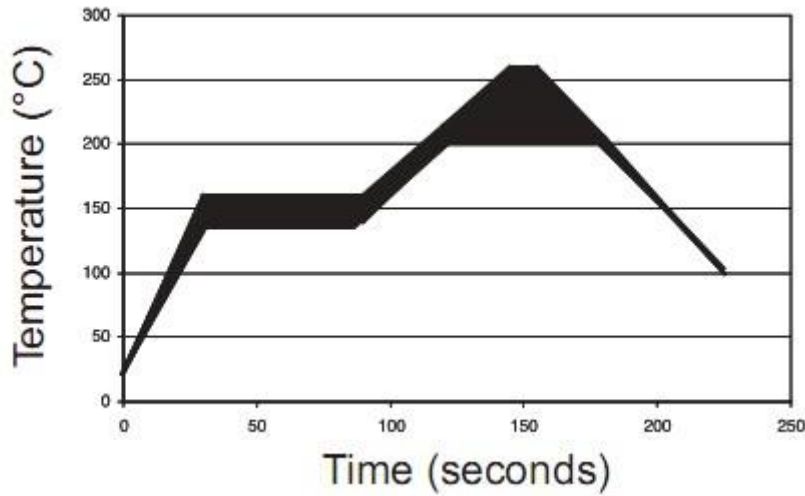
◆ Compatible with lead and lead-free solder reflow processes ◆

Recommended IR Reflow Profile :

Storage

Humidity :

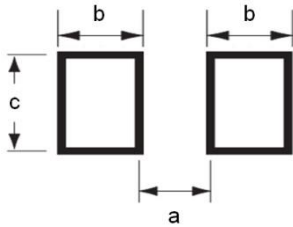
Solder Pad



Conditions

Temperature : 5~35°C,
40~75%

Recommended
Layout



| Type | Resistance Range (Ω) | Power Rating (watts) | Dimensions-mm (inches) | | |
|------|----------------------|----------------------|------------------------|-------------|-------------|
| | | | a | b | i |
| 0805 | 0.001~0.05 | 0.25W~0.5W (V)~(U) | 0.9(0.035) | 1.5(0.059) | 0.8(0.031) |
| 1206 | 0.001~0.12 | 0.5W~1W (U)~(T) | 1.5(0.059) | 1.95(0.077) | 0.8(0.031) |
| 2010 | 0.0005~0.029 | 1W~2W (T)~(S) | 2.25(0.089) | 2.9(0.114) | 1.5(0.059) |
| | 0.03~0.1 | | 1.6(0.063) | 2.9(0.114) | 3.14(0.124) |
| 2512 | 0.0005~0.0049 | 1W~1.5W (T)~(A) | 3(0.118) | 3.65(0.144) | 1.5(0.059) |
| | 0.0001~0.079 | | 2.2(0.087) | 3.65(0.144) | 3.14(0.124) |
| | 0.08~0.2 | | 1.9(0.075) | 3.65(0.144) | 3.6(0.141) |
| | 0.0005~0.0049 | 2W (S) | 3(0.118) | 3.65(0.144) | 1.5(0.059) |
| | 0.0005~0.079 | | 2.2(0.087) | 3.65(0.144) | 3.14(0.124) |
| | 0.001~0.003 | 3W (R) | 3(0.118) | 3.65(0.144) | 1.5(0.059) |
| 2725 | 0.0005~0.001 | 4W (E) | 3(0.118) | 7(0.27) | 1.5(0.059) |
| | 0.002~0.05 | 4W (E) | 2.2(0.087) | | 3.14(0.124) |
| | 0.051~0.1 | 3W (R) | 1.9(0.075) | | 3.6(0.141) |



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ECN

Engineering Change Notice : The customer will be informed with ECN if there is significant modification on the characteristics and materials described in Approval Sheet.

单击下面可查看定价，库存，交付和生命周期等信息

[>>ISND\(华信安\)](#)